TRANSMITTAL LETTER (General - Patent Pending)

Docket No. E0520CIP

Kashmir S. Sahota, Diana M. Schonauer, Johannes F. Groschopf, Gerd F.C. Marxsen, Steven A.

Avanzino

Serial No. 09/749,191

Filing Date December 26, 2000 Examiner

Group Art Unit

L. Umez-Eronini

1765

Title: "PREVENTION OF PRECIPITATION DEFECTS ON COPPER INTERCONNECTS DURING CMP BY USE OF SOLUTIONS CONTAINING ORGANIC COMPOUNDS WITH SILICA ADSORPTION AND COPPER CORROSION INHIBITING PROPERTIES"

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is

Response to Office Action (5 pp) **Return Receipt Postcard**

in the above identified application.

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Dated: March 18, 2003

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certify that this document and fee is being deposited with the U.S. Postal Service as onMarch 18, 2003 first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C.

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